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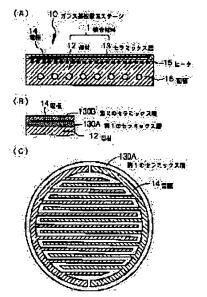
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(54) GLASS SUBSTRATE PROCESSOR

(57) Abstract:

PROBLEM TO BE SOLVED: To provide a glass substrate processor for preventing the generation of a damage due to the difference of thermal expansion between materials, for sufficiently standing its use at a high temperature, for processing a glass substrate with a large area, and for operating the high temperature processing of the substrate. SOLUTION: One part (for example, glass substrate mount stage 10) of a glass substrate processor for processing a glass substrate is constituted of a composite material 11. Then, the composite material 11 is constituted of a base metal 12 in which aluminum based materials are packed in the tissue of a ceramic material and a ceramic layer 13 formed on the surface of the base metal 12 by a spraying method.



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